

# 1 PRODUCT OVERVIEW

## SAM87RI PRODUCT FAMILY

Samsung's SAM88RCRI family of 8-bit single-chip CMOS microcontrollers offer fast and efficient CPU, a wide range of integrated peripherals, and support OTP device.

A dual address/data bus architecture and bit- or nibble-configurable I/O ports provide a flexible programming environment for applications with varied memory and I/O requirements. Timer/counters with selectable operating modes are included to support real-time operations.

## S3C9664 MICROCONTROLLER

The S3C9664 microcontroller with USB function can be used in a wide range of general purpose applications. It is especially suitable for joystick, game pad controller or mouse and is available in 20-pin DIP, 24-pin SDIP and 20, 24-pin SOP. The S3C9664 single-chip 8-bit microcontroller is fabricated using an advanced CMOS process. It is built around the powerful SAM88RCRI CPU core.

Stop and Idle power-down modes were implemented to reduce power consumption. To increase on-chip register space, the size of the internal register file was logically expanded. The S3C9664 has 4 K bytes of program memory on-chip, and 208 bytes of RAM including 16 bytes of working register. Using the SAM88RCRI design approach, the following peripherals were integrated with the SAM88RCRI core:

- Two configurable I/O ports (14 I/O pins on 20 pin package, 18 I/O pins on 24pin package)
- Analog-to-digital converter with six input channel and 10-bit resolution
- One 8-bit basic timer for watchdog function
- One 8 bit timer/counter with three operating modes (Timer 0)
- One 8 bit timer (Timer 1)

## OTP

The S3C9664 microcontroller is also available in OTP (One Time Programmable) version, S3P9664. S3P9664 microcontroller has an on-chip 4 K byte one-time-programmable EPROM instead of masked ROM. The S3P9664 is compatible to S3C9664, both in function and in pin configuration.

## FEATURES

### CPU

- SAM88RCRI CPU core

### Memory

- 4-K byte internal program memory
- 208-byte general purpose register area
- 16 bytes of working register

### Instruction Set

- 41 instructions
- IDLE and STOP instructions added for power-down modes

### Instruction Execution Time

- 0.66  $\mu$ s at 6 MHz  $f_{OSC}$

### Interrupts

- 28 interrupt sources and one vector (24 pins)
- 24 interrupt sources and one vector (20 pin)
- One interrupt level

### General I/O

- Three I/O ports (total 18 I/O pins at 24 SOP/SDIP)
- Three I/O ports (total 14 I/O pins at 20 SOP/DIP)

### Timer/Counter

- One 8-bit basic timer for watchdog function
- One 8 bit timer/counter with three operating modes(Match, capture, PWM)
- One 8-bit Timer

### USB

- Compatible to USB low speed (1.5 Mbps) device 1.1 specification.
- Serial bus interface engine (SIE)
  - Packet decoding/generation
  - CRC generation and checking
  - NRZI encoding/decoding and bit-stuffing
- Two 8-byte receive/transmit USB buffer

### A/D Converter

- Six analog input pins
- 10-bit conversion resolution

### Low Voltage Reset

- Low voltage reset
- Power on Reset

### Sub Oscillator

- Internal RC sub oscillator
- Auto interrupt wake-up

### Oscillator Frequency

- 6 MHz crystal/ceramic oscillator
- External clock source (6 MHz)

### Operating Temperature Range

- $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$

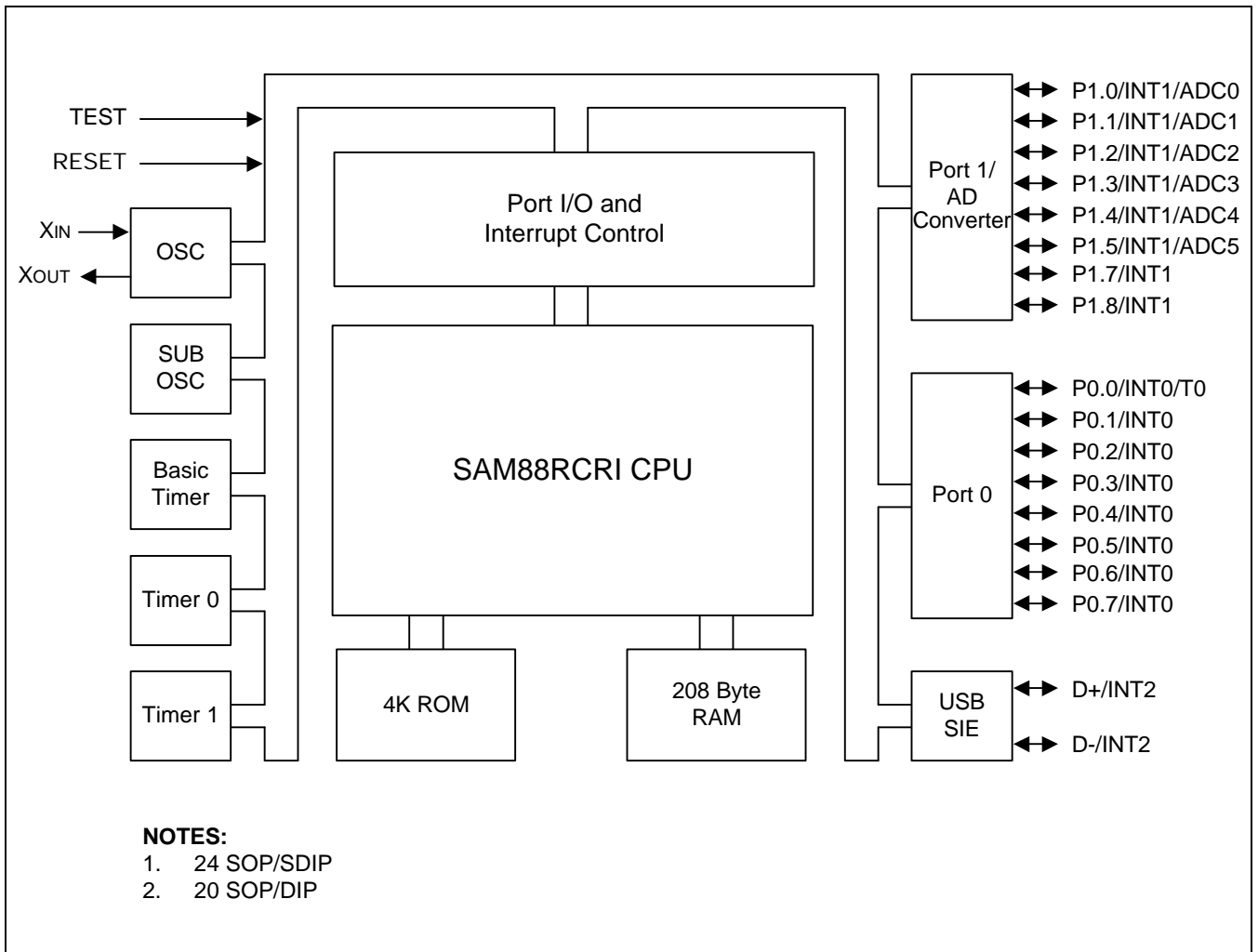
### Operating Voltage Range

- 4.0 V to 5.25 V

### Package Types

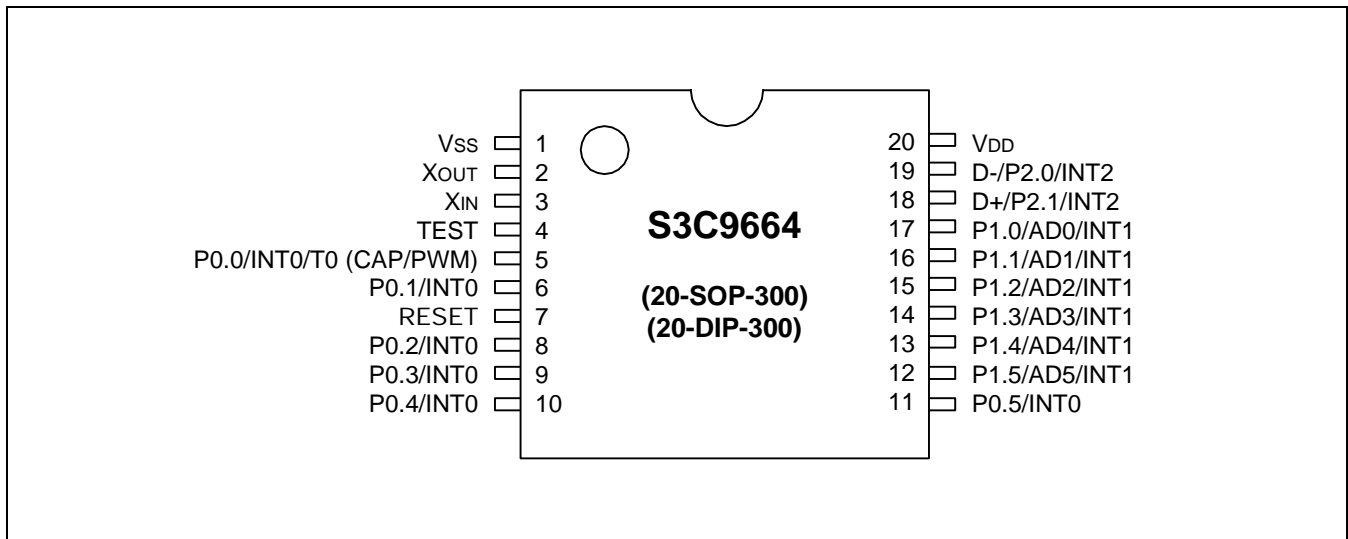
- 24-pin SOP/SDIP
- 20-pin SOP/DIP

**BLOCK DIAGRAM**

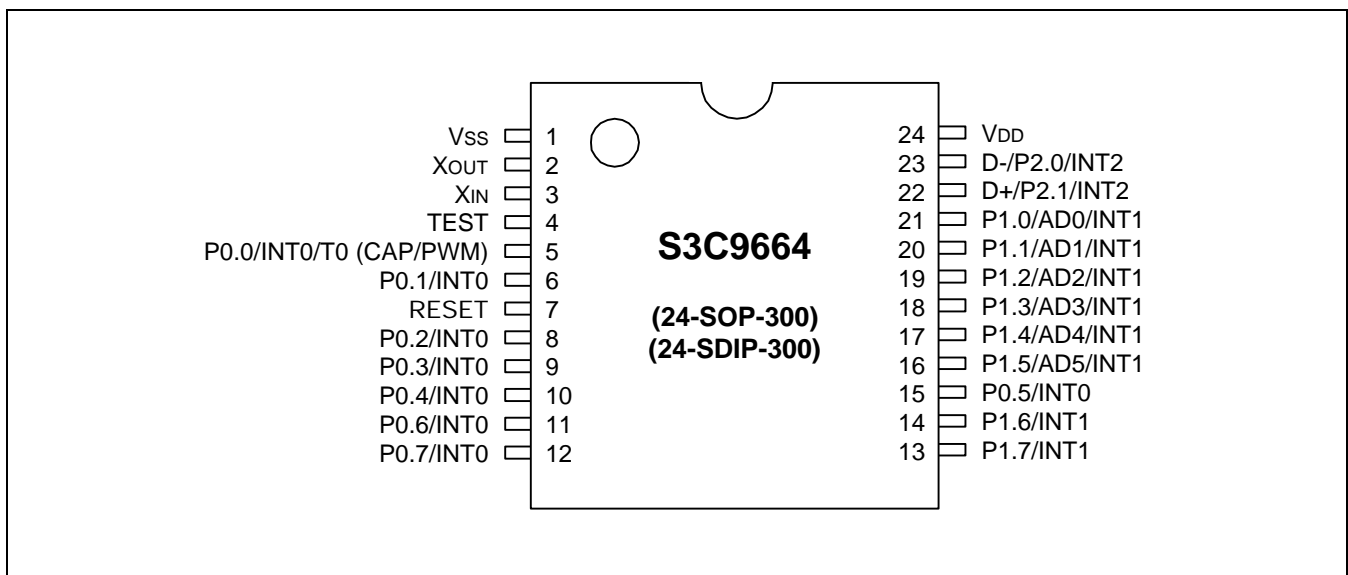


**Figure 1-1. Block Diagram**

**PIN ASSIGNMENTS**



**Figure 1-2. Pin Assignment (20 Pin)**



**Figure 1-3. Pin Assignment (24 Pin)**

Table 1-1. Pin Descriptions

Pin Name	In/Out	Pin Description	Pin Type	Pin Numbers	Share Pins
P0.0–P0.7	I/O	Bit-programmable I/O port for Schmitt trigger input , push-pull output and N-Ch open drain output. Pull-up/ pull-down resistors are assignable by software. Port1 pins can also be used as external interrupt.	G	5,6,8–11 (5,6,8–12,15)	T0, INT0
P1.0–P1.5	I/O	Bit-programmable I/O port for Schmitt trigger input, Schmitt trigger input with pull-up and N-Ch open drain output. Port1 pins can also be used as A/D converter Channel.	F	12–17 (16–21)	AD0–5 INT1
P1.6–P1.7	I/O	Bit-programmable I/O port for Schmitt trigger input , Schmitt trigger input with pull-up and N-Ch open drain output and Push-pull output.	E	(13–14)	INT1
P2.0/D– – P2.1/D+	I/O	Bit-programmable I/O port for Schmitt trigger input , Schmitt trigger input with pull-up and N-Ch open drain output and Push-pull output. Port 2 can be individually configured as external interrupt inputs. Also it can be configured as an USB ports	E	18–19 (22–23)	INT2
X <sub>IN</sub> , X <sub>OUT</sub>	–	Crystal/ceramic oscillator signal for system clock.	–	2–3 (2–3)	–
RESET	I	System reset signal input pin.	B	7 (7)	–
TEST	I	Test signal input pin(for factory use only; muse be connected to V <sub>SS</sub> )	–	4 (4)	–
V <sub>DD</sub> , V <sub>SS</sub>	–	Voltage input pin and ground	–	1,20 (1,24)	–
T0	I/O	Timer 0 capture input or PWM output pin	G	6 (6)	P0.0
INT0	I	External interrupt input	G	5,6,8–11 (5,6,8–12,15)	P0.0–P0.7
INT1	I	External interrupt input	F,E	12–17 (13–14, 16–21)	P1.0–P1.7
INT2	I	External interrupt input	E	18–19	P2.0–P2.1
AD0–AD5	I	A/D converter input	F	12–17 (16–21)	P1.0–P1.5

**NOTE:** Pin numbers show in parentheses "( )" are for the 24-pin package

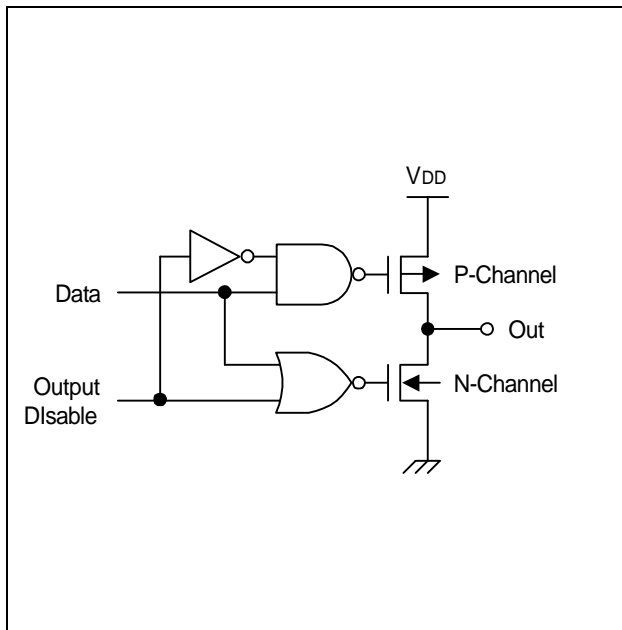


Figure 1-4. Pin Circuit Type C

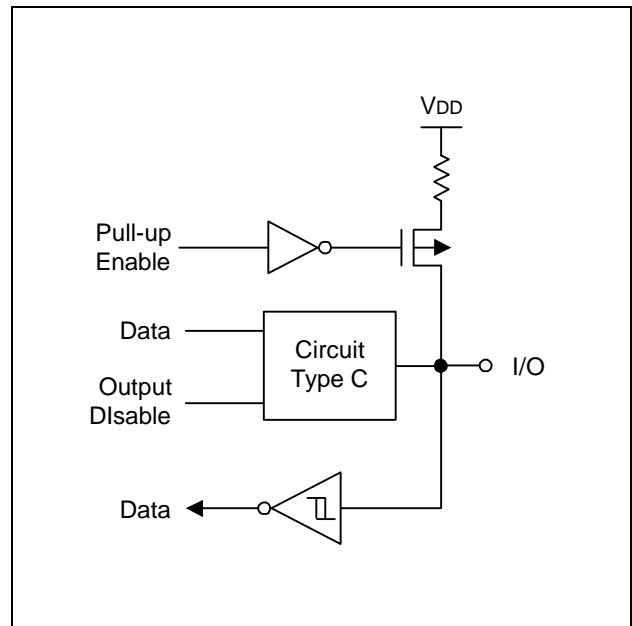


Figure 1-5. Pin Circuit Type D

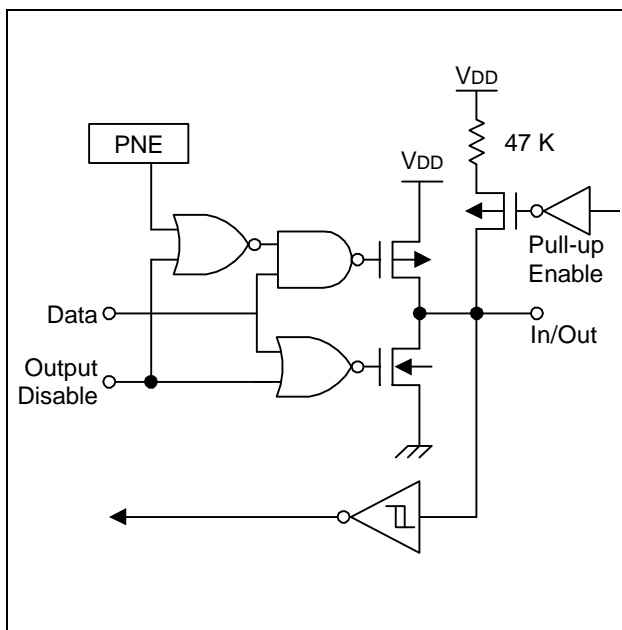


Figure 1-6. Pin Circuit Type E

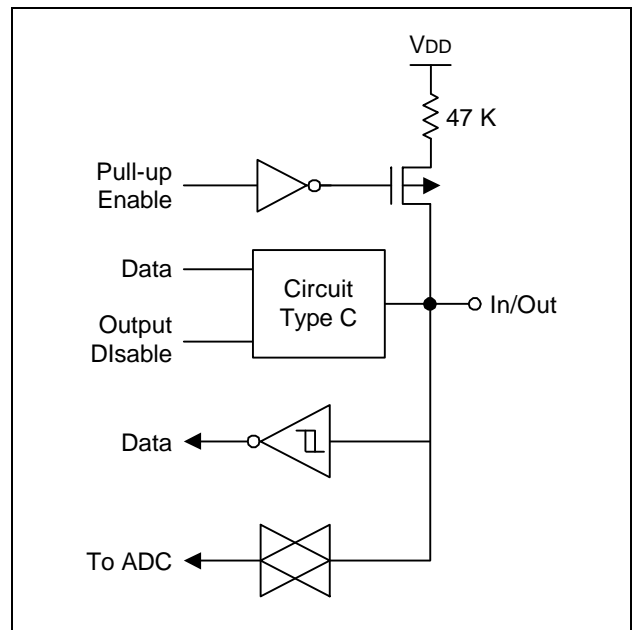


Figure 1-7. Pin Circuit Type F

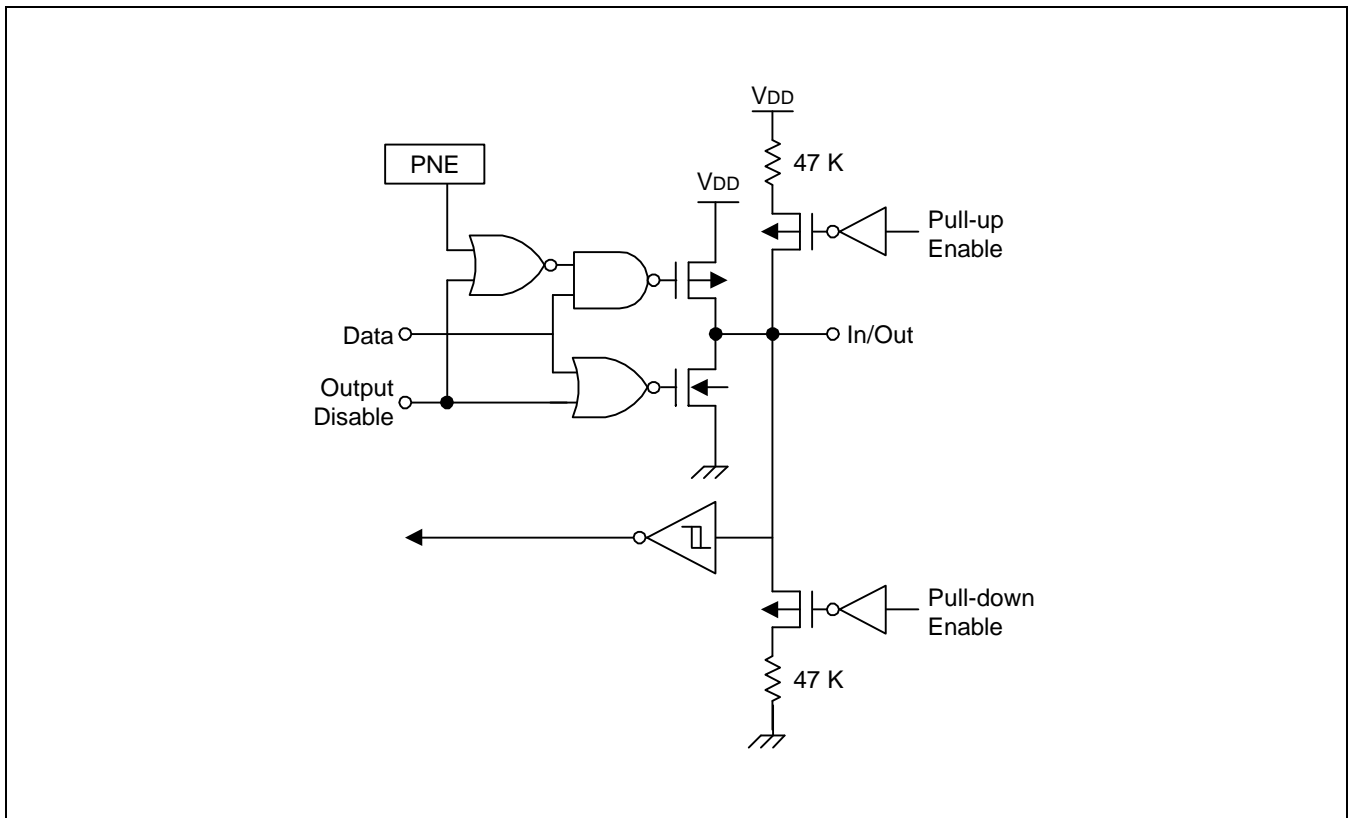


Figure 1-8. Pin Circuit Type G

# 16

## ELECTRICAL DATA

### OVERVIEW

In this section, the following S3C9664 electrical characteristics are presented in tables and graphs:

- Absolute maximum ratings
- D.C. electrical characteristics
- I/O capacitance
- A.C. electrical characteristics
- Oscillator characteristics
- Operating voltage range
- Oscillation stabilization time
- Clock timing measurement points at  $X_{IN}$
- Data retention supply voltage in Stop mode
- Stop mode release timing when initiated by a RESET
- Stop mode release timing when initiated by an external interrupt
- Characteristic curves
- AD Converter Electrical Characteristics



Table 16-1. Absolute Maximum Ratings

 $(T_A = 25^\circ\text{C})$ 

Parameter	Symbol	Conditions	Rating	Unit
Supply voltage	$V_{DD}$	–	– 0.3 to + 6.5	V
Input voltage	$V_I$	All ports	– 0.3 to $V_{DD} + 0.3$	V
Output voltage	$V_O$	All output ports	– 0.3 to $V_{DD} + 0.3$	V
Output current high	$I_{OH}$	One I/O pin active	– 18	mA
		All I/O pins active	– 60	
Output current low	$I_{OL}$	One I/O pin active	+ 30	mA
		Total pin current for ports 0, 1, 2	+ 100	
Operating temperature	$T_A$	–	0 to + 85	°C
Storage temperature	$T_{STG}$	–	– 60 to + 150	

Table 16-2. D.C. Electrical Characteristics

(T<sub>A</sub> = -40°C to +85°C, V<sub>DD</sub> = 4.0 V to 5.25 V)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Input highvoltage	V <sub>IH1</sub>	All input pins except V <sub>IH2</sub> , D+, D-	0.8 V <sub>DD</sub>	-	V <sub>DD</sub>	V
	V <sub>IH2</sub>	X <sub>IN</sub>	V <sub>DD</sub> - 0.5		V <sub>DD</sub>	
Input low voltage	V <sub>IL1</sub>	All input pins except V <sub>IL2</sub> , D+, D-	-	-	0.2 V <sub>DD</sub>	
	V <sub>IL2</sub>	X <sub>IN</sub>	-	-	0.4	
Output high voltage	V <sub>OH</sub>	V <sub>DD</sub> = 4.0 V - 5.25 V I <sub>OH</sub> = -200 mA All output ports except D+, D-	V <sub>DD</sub> - 1.0	-	-	
Output low voltage	V <sub>OL</sub>	V <sub>DD</sub> = 4.0 V - 5.25 V I <sub>OL</sub> = 2 mA All output ports except D+, D-	-	-	0.4	
Input high leakage current	I <sub>LIH1</sub>	V <sub>IN</sub> = V <sub>DD</sub> All inputs except I <sub>LIH2</sub> except D+, D-, X <sub>OUT</sub>	-	-	3	μA
	I <sub>LIH2</sub>	V <sub>IN</sub> = V <sub>DD</sub> , X <sub>IN</sub>	-	-	20	
Input low leakage current	I <sub>LIL1</sub>	V <sub>IN</sub> = 0 V All inputs except I <sub>LIL2</sub> except D+, D-, X <sub>OUT</sub>	-	-	-3	
	I <sub>LIL2</sub>	V <sub>IN</sub> = 0 V, X <sub>IN</sub>	-	-	-20	
Output high leakage current	I <sub>LOH</sub>	V <sub>OUT</sub> = V <sub>DD</sub> All output pins except D+, D-	-	-	3	
Output low leakage current	I <sub>LOL</sub>	V <sub>OUT</sub> = 0 V All output pins except D+, D- X <sub>OUT</sub>	-	-	-3	
Pull-up resistors	R <sub>L1</sub>	V <sub>IN</sub> = 0 V, V <sub>DD</sub> = 5.0 V, Port 0, Port 1, Port 2	25	50	100	KΩ
	R <sub>L2</sub>	V <sub>IN</sub> = 0 V, V <sub>DD</sub> = 5.0 V, RESET only	100	220	400	
Pull-down resistors	R <sub>L3</sub>	V <sub>IN</sub> = 0 V, V <sub>DD</sub> = 5.0 V, Port 0	25	50	100	KΩ
Supply current	I <sub>DD1</sub>	Normal operation mode, V <sub>DD</sub> = 5 V ± 10 %, 6 MHz, CPU clock	-	6.5	15	mA
	I <sub>DD2</sub>	IDLE mode V <sub>DD</sub> = 5 V ± 10 %, 6 MHz, CPU clock	-	4	8	
	I <sub>DD3</sub>	Stop mode, oscillator stop V <sub>DD</sub> = 5 V ± 10 %,	-	150	300	μA

**NOTES:**

1. Supply current does not include current drawn through internal pull-up resistors or external output current load.
2. This parameter is guaranteed, but not tested (include D+, D-).
3. Only in 4.0 V to 5.25 V, D+ and D- satisfy the USB spec 1.1.

## ELECTRICAL DATA

## S3C9664/P9664 (Preliminary Spec)

Table 16-3. Input/Output Capacitance

 $(T_A = 0^\circ\text{C to } +85^\circ\text{C}, V_{DD} = 0\text{ V})$ 

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Input capacitance	$C_{IN}$	$f = 1\text{ MHz}$ ; unmeasured pins are connected to $V_{SS}$	-	-	10	pF
Output capacitance	$C_{OUT}$					
I/o capacitance	$C_{IO}$	expect $X_{IN}$ , $X_{OUT}$				
XI/XO capacitance	$C_{XI}$ , $C_{XO}$	$X_{IN}$ , $X_{OUT}$			33	

Table 16-4. A.C. Electrical Characteristics

 $(T_A = -40^\circ\text{C to } +85^\circ\text{C}, V_{DD} = 4.0\text{ V to } 5.25\text{ V})$ 

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Noise filter	$t_{NF1H}$ , $t_{NF1L}$	P1 (RC delay)	100	-	200	ns

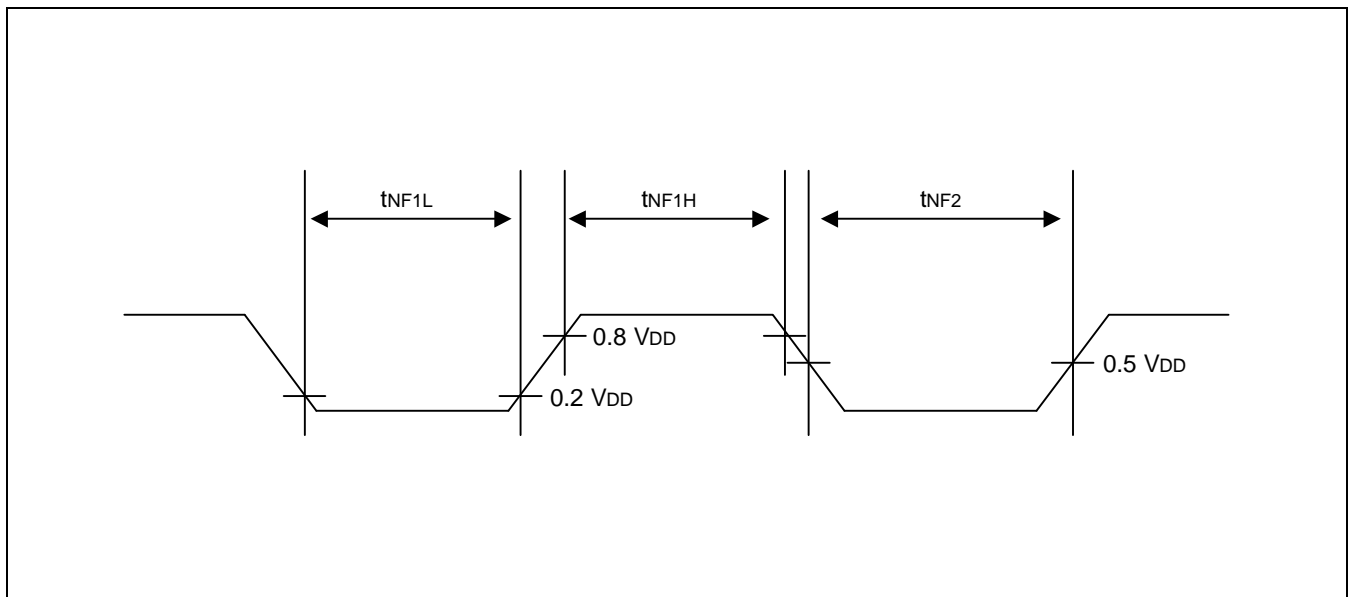


Figure 16-1. Input Timing for External Interrupts

Table 16-5. Oscillator Characteristics

 $(T_A = 0^\circ\text{C} + 85^\circ\text{C})$ 

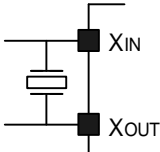
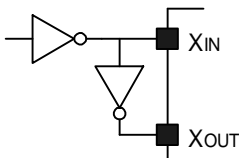
Oscillator	Clock Circuit	Test Condition	Min	Typ	Max	Unit
Main crystal Main ceramic ( $f_{\text{OSC}}$ )		Oscillation frequency $V_{\text{DD}} = 4.0\text{ V} - 5.25\text{ V}$	–	6.0	–	MHz
External clock		Oscillation frequency $V_{\text{DD}} = 4.0\text{ V} - 5.25\text{ V}$	–	6.0	–	

Table 16-6. Oscillation Stabilization Time

 $(T_A = 0^\circ\text{C} + 85^\circ\text{C}, V_{\text{DD}} = 4.0\text{ V to } 5.25\text{ V})$ 

Oscillator	Test Condition	Min	Typ	Max	Unit
Main crystal	$V_{\text{DD}} = 4.0\text{ V to } 5.25\text{ V}, f_{\text{OSC}} > 6.0\text{ MHz}$ (Oscillation stabilization occurs when $V_{\text{DD}}$ is equal to the minimum oscillator voltage range.)	–	–	10	ms
Main ceramic					
Oscillator stabilization wait time	$t_{\text{WAIT}}$ stop mode release time by a reset	–	$2^{16}/f_{\text{OSC}}$	–	
	$t_{\text{WAIT}}$ stop mode release time by an interrupt	–	–	–	

**NOTE:** The oscillator stabilization wait time,  $t_{\text{WAIT}}$ , when it is released by an interrupt, is determined by the setting in the basic timer control register, BTCON.

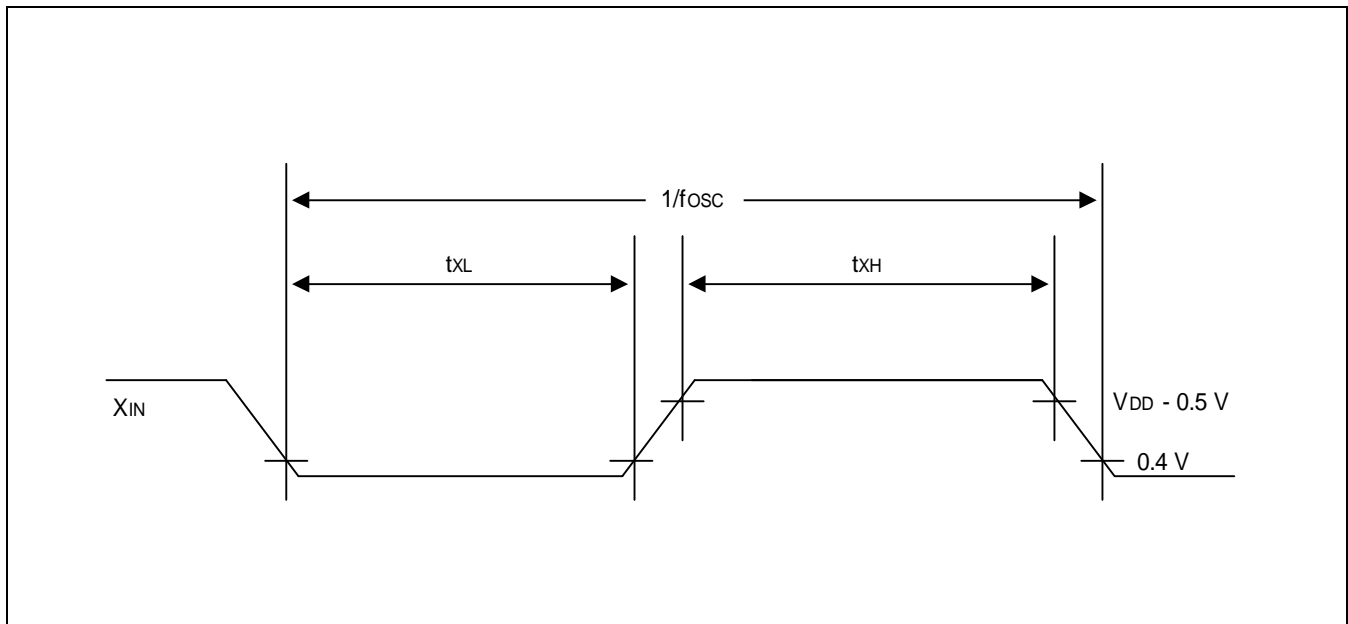
Figure 16-2. Clock Timing Measurement Points at X<sub>IN</sub>

Table 16-7. Data Retention Supply Voltage in Stop Mode

(T<sub>A</sub> = 0°C to +70°C)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Data retention supply voltage	V <sub>DDDR</sub>	Stop mode	2.0	–	6	V
Data retention supply current	I <sub>DDDR</sub>	Stop mode; V <sub>DDDR</sub> = 2.0 V	–	–	5	μA

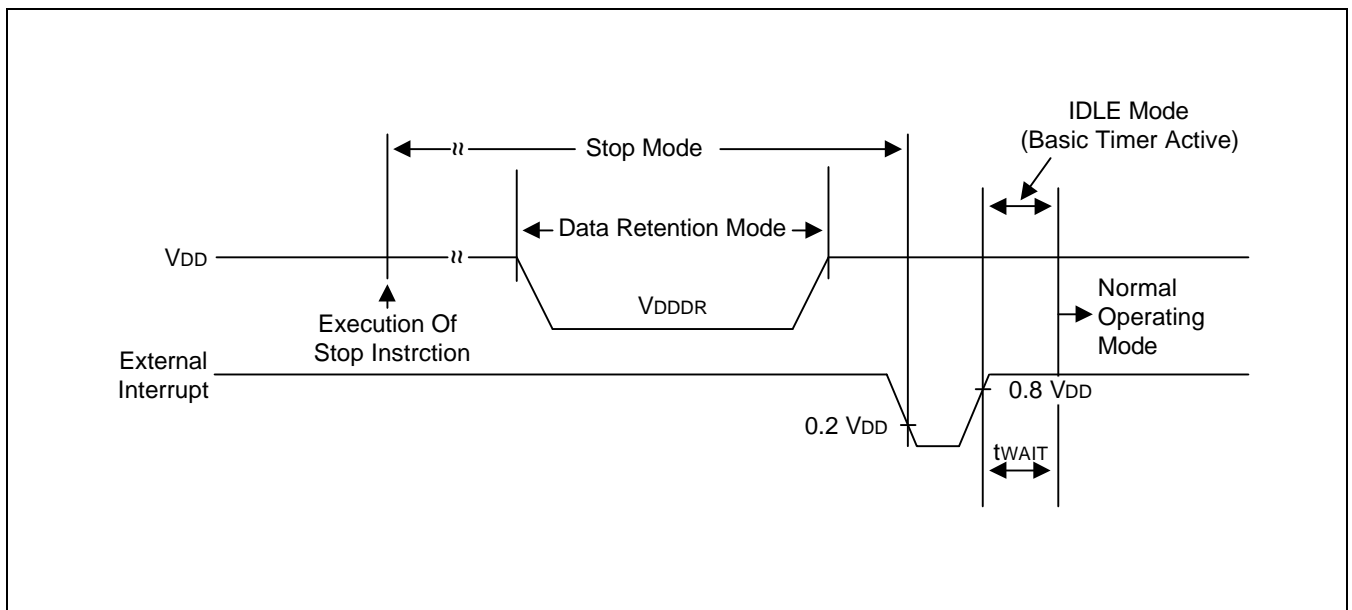


Figure 16-3. Stop Mode Release Timing When Initiated by an External Interrupt

Table 16-8. Low Speed Source Electrical Characteristics (USB)

( $T_A = 0^\circ\text{C}$  to  $+85^\circ\text{C}$ , Voltage Regulator Output  $V_{33\text{OUT}} = 2.8\text{ V}$  to  $3.5\text{ V}$ , typ  $3.3\text{ V}$ )

Parameter	Symbol	Conditions	Min	Max	Unit
Transition Time:					
Rise Time	$T_r$	$CL = 200\text{ pF}$	75	–	ns
Fall Time	$T_f$	$CL = 650\text{ pF}$	–	300	
		$CL = 200\text{ pF}$	75	–	
		$CL = 650\text{ pF}$	–	300	
Rise/Fall Time Matching	$T_{rfm}$	$(T_r/T_f) CL = 50\text{ pF}$	80	125	%
Output Signal Crossover Voltage	$V_{crs}$	$CL = 50\text{ pF}$	1.3	2.0	V
Output Voltage Regulator Built-in	$V_{33\text{OUT}}$	$V_{DD} = 4.0\text{--}5.25\text{ V}$	2.8	3.6	V

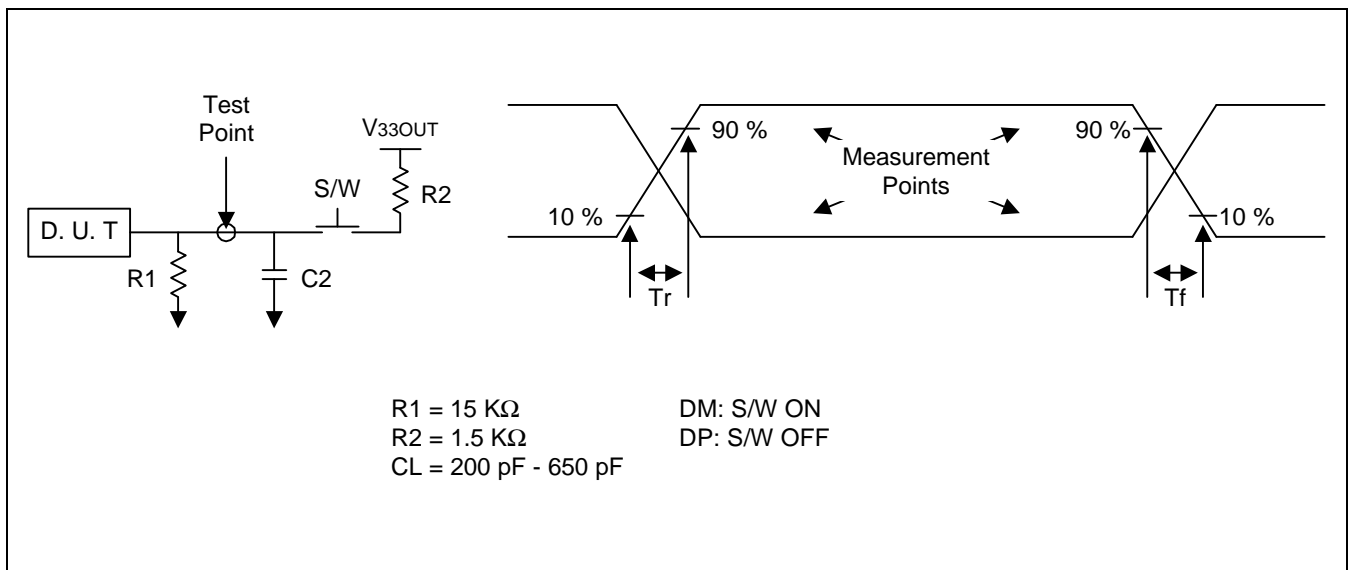


Figure 16-4. USB Data Signal Rise and Fall Time

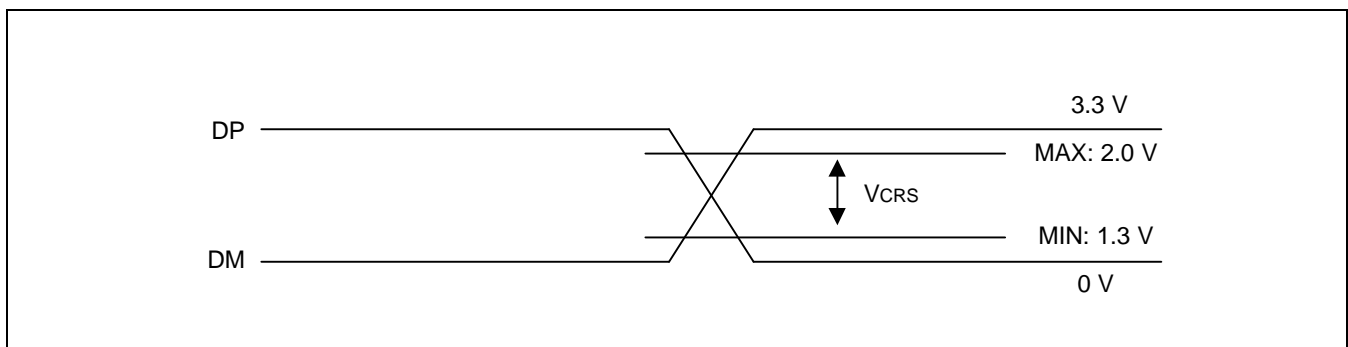


Figure 16-5. USB Output Signal Crossover Point Voltage

Table 16-9. A/D Converter Electrical Characteristics

(T<sub>A</sub> = -40°C to +85°C, V<sub>DD</sub> = 4.2 V to 5.25 V, V<sub>SS</sub> = 0 V) S3C9664/P9664: 10-bit ADC

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Total accuracy		V <sub>DD</sub> = 5.12 V CPU clock = 10 MHz V <sub>DD</sub> = 5.12 V V <sub>SS</sub> = 0 V	-	-	± 3	LSB
Integral linearity error	ILE	-		-	± 2	
Differential linearity error	DLE	-		-	± 1	
Offset error of top	EOT	-		- 1	± 3	
Offset error of bottom	EOB	-		- 1	± 2	
Conversion time <sup>(1)</sup>	t <sub>CON</sub>	f <sub>cpu</sub> = 10 MHz	-	50x4/ f <sub>OSC</sub>	-	μs
Analog input voltage	V <sub>IAN</sub>	-	V <sub>SS</sub>	-	V <sub>DD</sub>	V
Analog input impedance	R <sub>AN</sub>	-	2	-	-	MΩ
Analog input current	I <sub>ADIN</sub>	V <sub>DD</sub> = 5 V	-	-	10	μA
ADC block current <sup>(2)</sup>	I <sub>ADC</sub>	V <sub>DD</sub> = 5 V	-	1	3	mA
		V <sub>DD</sub> = 5 V Power down mode	-	100	500	nA

**NOTES:**

- 'Conversion time' is the time required from the moment a conversion operation starts until it ends.
- I<sub>ADC</sub> is operating current during A/D conversion.



# 17

## MECHANICAL DATA

### OVERVIEW

This section contains the following information about the device package:

- Package dimensions in millimeters
- Pad diagram

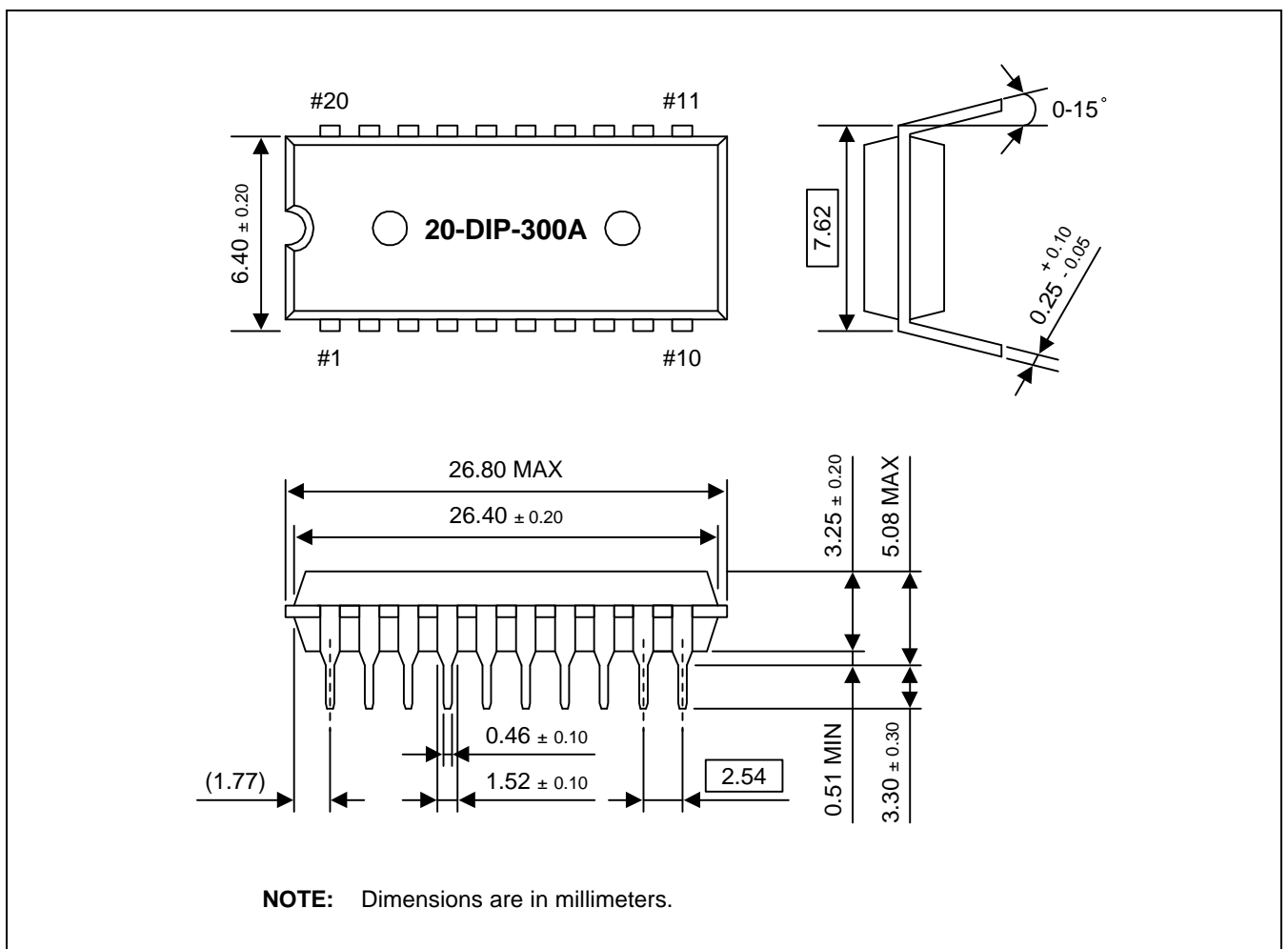


Figure 17-1. 20-DIP-300A Package Dimensions

MECHANICAL DATA

S3C9664/P9664 (Preliminary Spec)

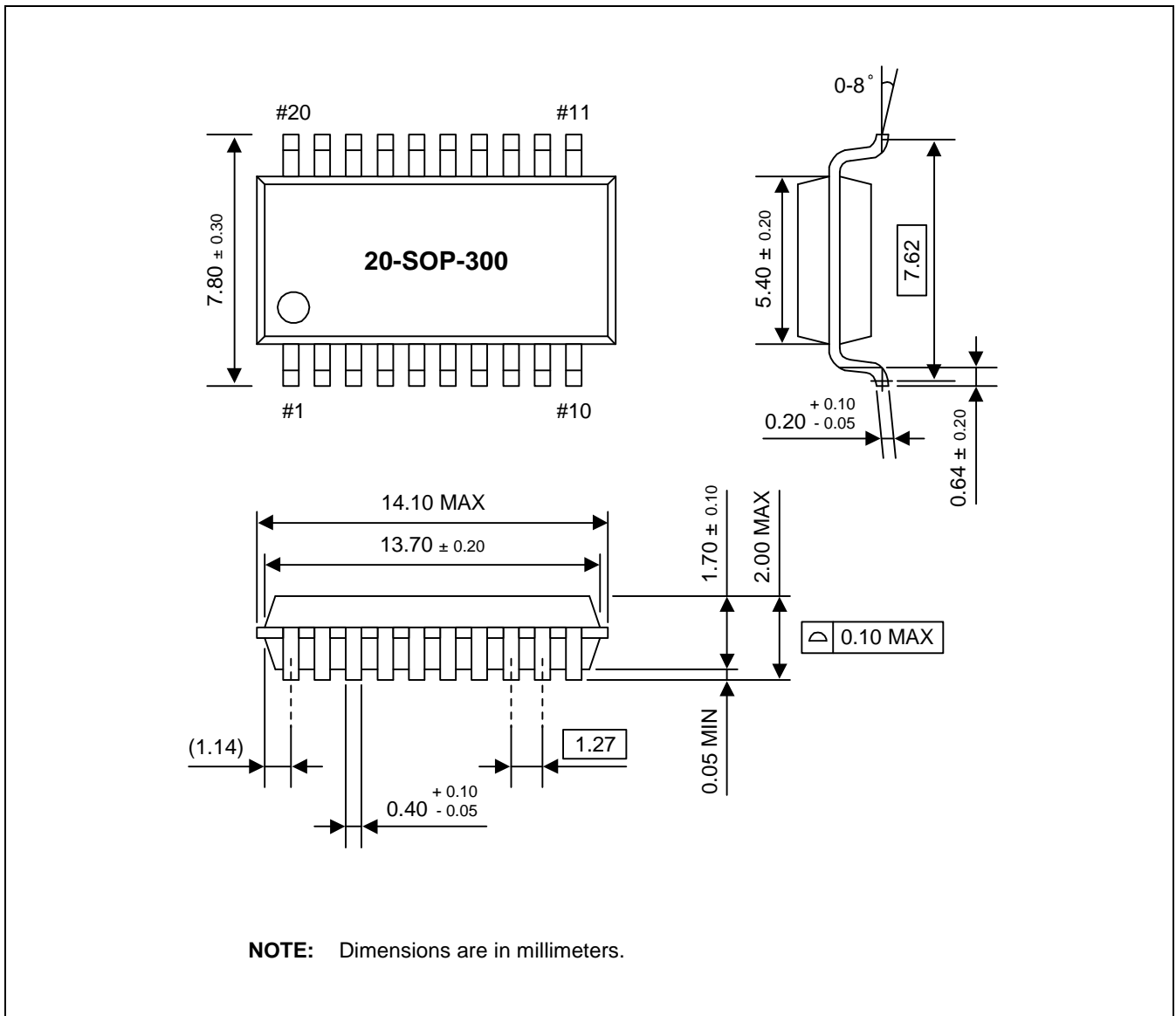


Figure 17-2. 20-SOP-300 Package Dimensions

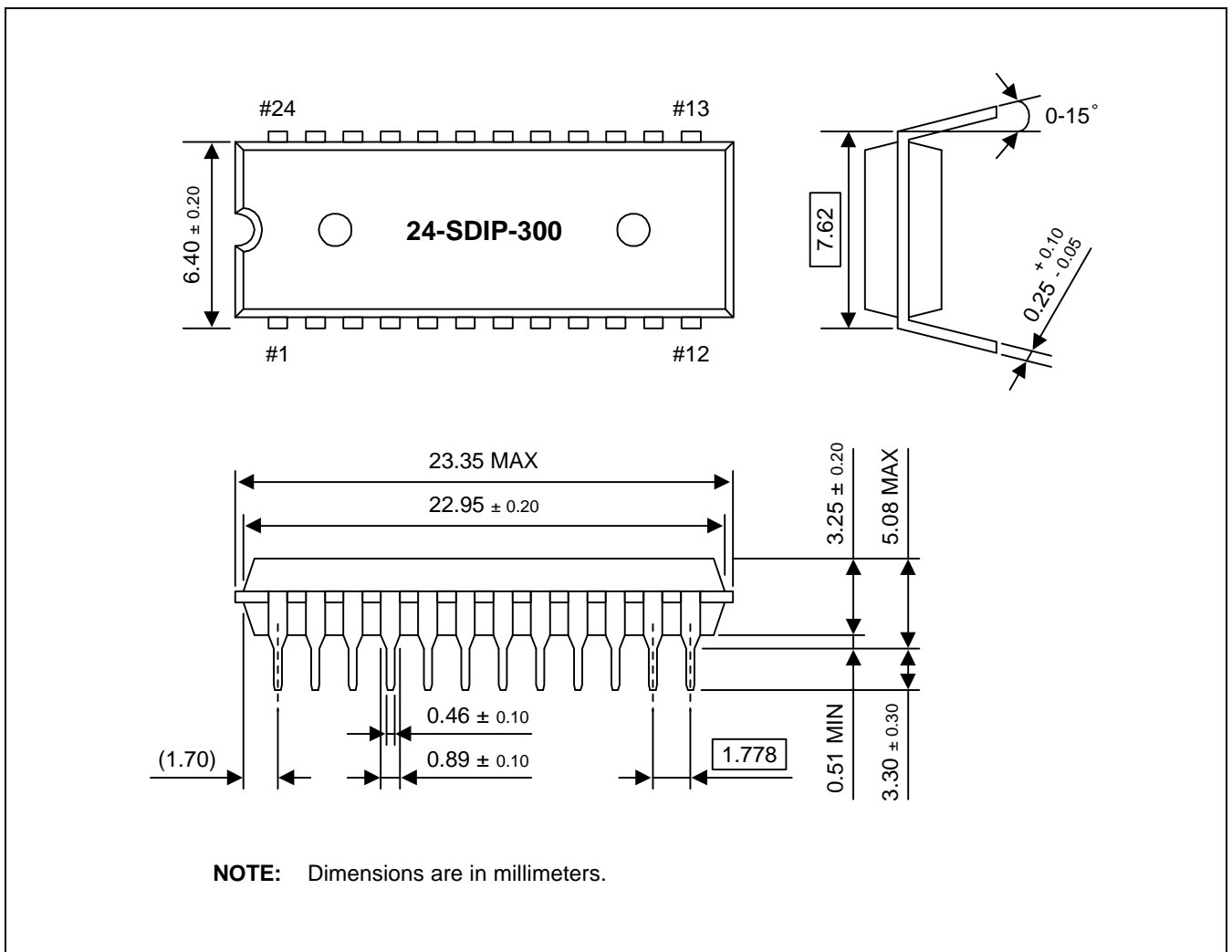


Figure 17-3. 24-SDIP-300 Package Dimensions

MECHANICAL DATA

S3C9664/P9664 (Preliminary Spec)

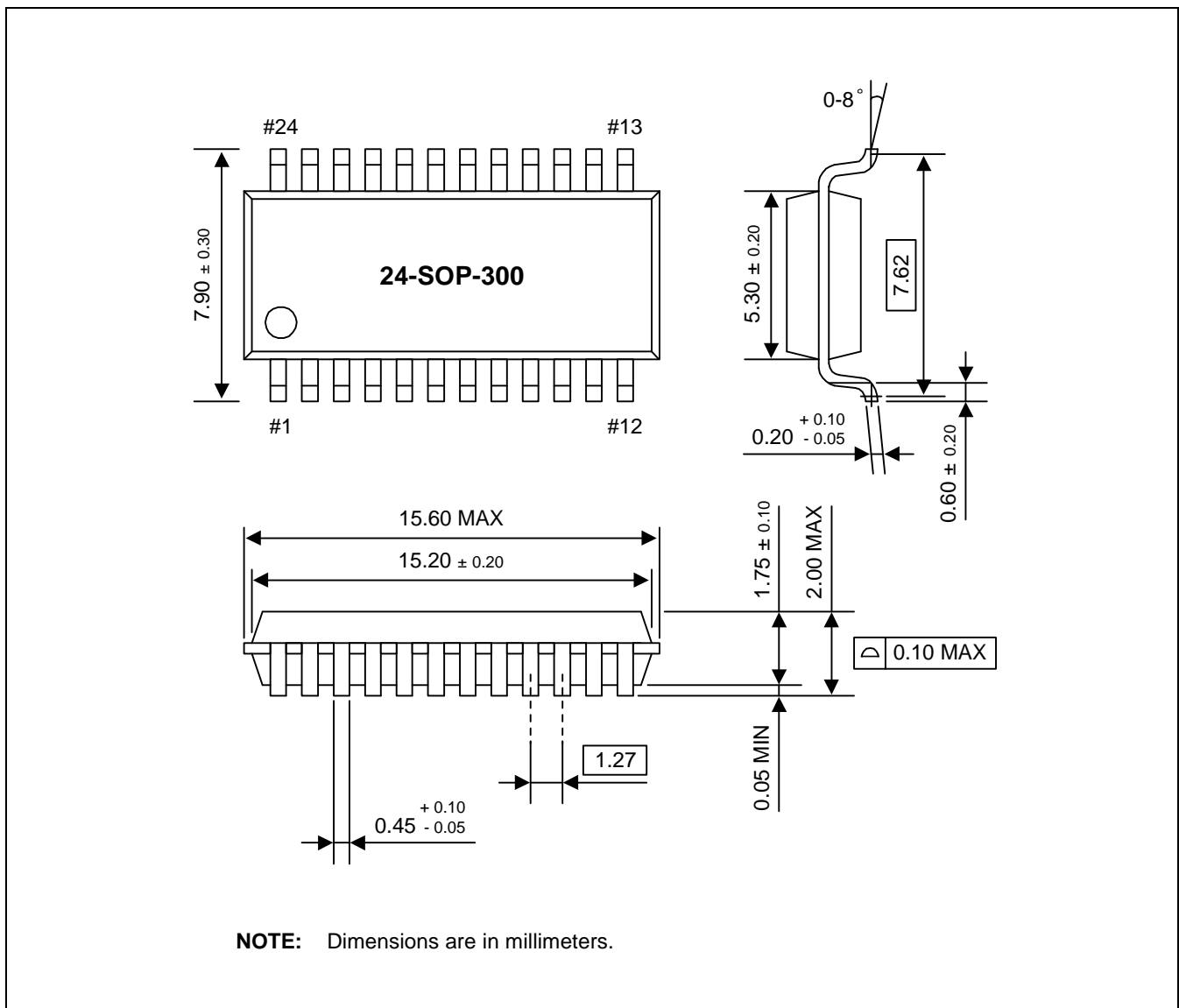


Figure 17-4. 24-SOP-300 Package Dimensions

# 18

## S3P9664 OTP

### OVERVIEW

The S3C9664 single-chip CMOS microcontroller is the OTP (One Time Programmable) version of the S3C9664 microcontroller. It has an on-chip OTP ROM instead of masked ROM. The EPROM is accessed by serial data format.

The S3P9664 is fully compatible with the S3C9664, both in function and in pin configuration. Because of its simple programming requirements, the S3P9664 is ideal for use as an evaluation chip for the S3C9664.

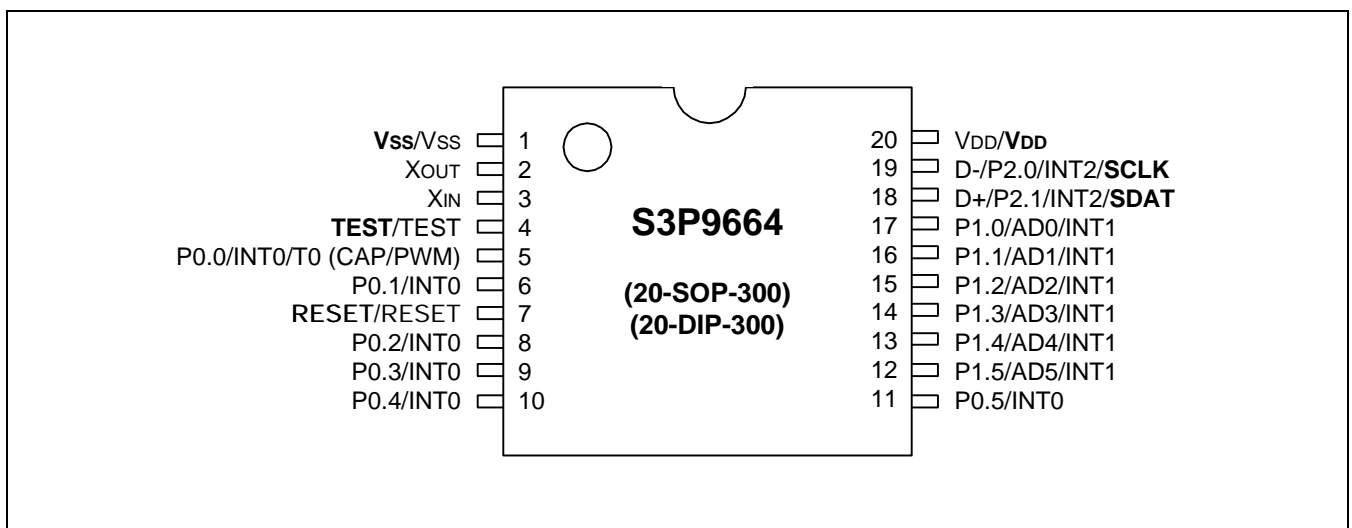


Figure 18-1. S3P9664 Pin Assignments (20-Pin Package)

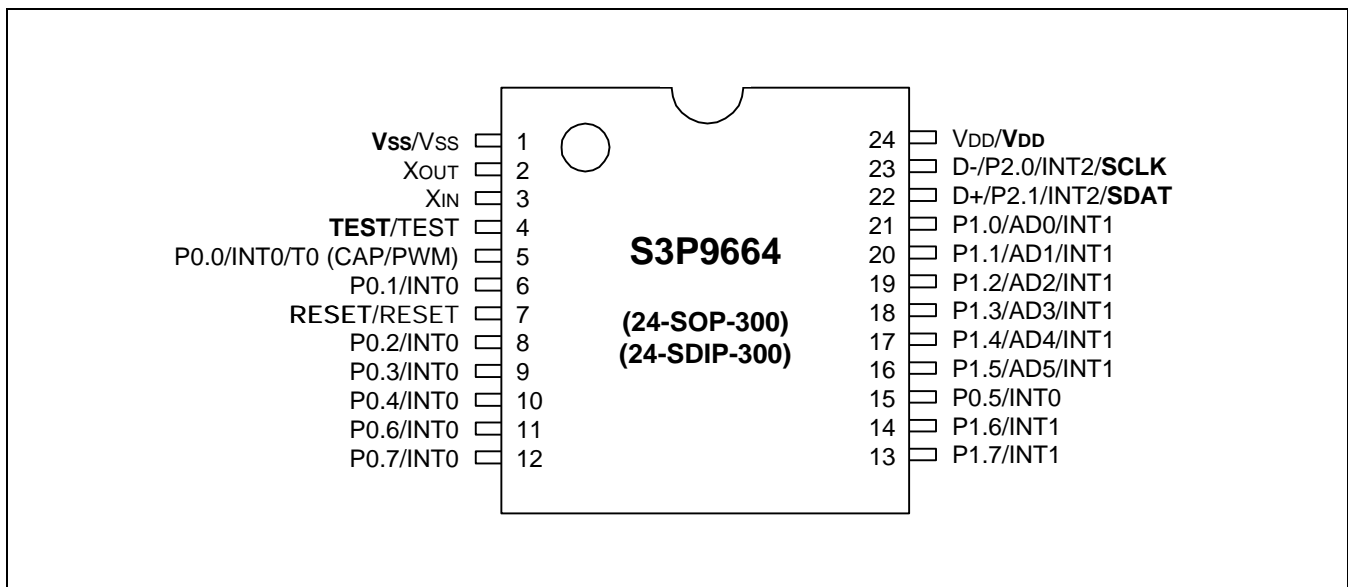


Figure 18-2. S3P9664 Pin Assignments (24-Pin Package)

Table 18-1. Descriptions of Pins Used to Read/Write the EPROM

Main Chip Pin Name	During Programming			
	Pin Name	Pin No. (24 DIP)	I/O	Function
P1.0	SDAT	23	I/O	Serial Data Pin (Output when reading, Input when writing) Input and Push-pull Output Port can be assigned
P1.1	SCLK	22	I/O	Serial Clock Pin (Input Only Pin)
TEST	$V_{PP}$ (TEST)	5	I	0V : OTP write and test mode 5V : Operating mode
RESET	RESET	8	I	Chip Initialization and EPROM Cell Writing Power Supply Pin (Indicates OTP Mode Entering) When writing 12.5V is applied and when reading.
$V_{DD}/V_{SS}$	$V_{DD}/V_{SS}$	24/1	I	Logic Power Supply Pin.

Table 18-2. Comparison of S3P9664 and S3C9664 Features

Characteristic	S3P9664	S3C9664
Program Memory	4 K byte EPROM	4 K byte mask ROM
Operating Voltage ( $V_{DD}$ )	4.0 V to 5.25 V	4.0 V to 5.25 V
OTP Programming Mode	$V_{DD} = 5 V$ , $V_{PP}$ (RESET) =12.5V	
Pin Configuration	20 SOP/20 DIP/24 SOP/24 SDIP	20 SOP/20 DIP/24 SOP/24SDIP
EPROM Programmability	User Program 1 time	Programmed at the factory